

50Ω 104 to 176 MHz

Operating Temperature -55°C to 100°C

Storage Temperature	-55°C to 100°C
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LO/RF Power	50mW
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I&Q Current	40mA
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Permanent damage may occur if any of these limits are exceeded.

LO (carrier)	2
RF (signal)	9
I (0°)(ref.)	4
Q (90°)*	11
GROUND	1,3,5,6,7,8,10,12,13,14

$$Q = +90^\circ \text{ for } LO < RF$$
$$Q = -90^\circ \text{ for } LQ > RF$$

A	B	C	D	E	F	G
.870	.800	--	.100	.250	.100	.100
22.10	20.32	--	2.54	6.35	2.54	2.54
H	J	K	L			wt
.047	.065	.065	.890			grams
1.19	1.65	1.65	22.61			4.0

Figure 1: Dimensions for 32X Pin Grid Array (PGA) Package. The diagram shows the top and bottom views of the package with various dimensions and labels. Key dimensions include .020 TYP, .050, .100 TYP, .020, 2 PL, .040, 2 PL, .050 TYP, .110, 2 PL, .080, 2 PL, .067 TRACE WIDTH, 4 PL, .210, 2 PL, and .040 TYP. Labels include '32X #.020 PTH FOR GROUND', 'PACKAGE OUTLINE', and 'PIN 1'.

NOTE:

- NOTE:**
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" $\pm$.002"; COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

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- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

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Generic photo used for illustration purposes only

CASE STYLE: BG291

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

- shielded metal case with J-leads
- excellent 3rd & 5th order harmonic suppression
- good amplitude & phase unbalance
- aqueous washable

- communication systems

MODEL NO.	FREQUENCY (MHz)				CONVERSION LOSS (dB)			AMPLITUDE UNBALANCE (dB)		PHASE UNBALANCE (Deg.)		HARMONIC SUPPRESSION (dBc)			
	RF (SIGNAL)		LO (CARRIER)		I&Q					with reference to 90°		3X1/Q		5X1/Q	
	f _i	f _{ll}	Min.	Max.	$\bar{x}$	σ	Max.	Typ.	Max.	Typ.	Max.	Typ.	Min.	Typ.	Min.
JCIQ-176D	104	176	DC	5	5.5	0.1	7.0	0.15	0.6	2	5	52	40	65	50

Notes:

1. Operating LO Power: 10±0.5 dBm
2. 1 dB Compression at +4 dBm RF input
3. DC offset 1mV typ.
4. Conversion Loss=RF power, dBm - (I+Q) power, dBm

Frequency (MHz)		Conversion Loss (dB)	Amplitude Unbalance (dB)	Phase (I&Q) (deg.)	Frequency (MHz)		DC Offset (mV)
LO=140MHz	RF I&Q				LO	RF	
140.30	0.30	5.67	0.07	90.71	96.00	96.10	0.18
140.54	0.54	5.61	0.08	90.55	100.00	100.10	0.19
140.77	0.77	5.56	0.07	90.69	104.00	104.10	0.19
141.01	1.01	5.55	0.09	90.71	107.79	107.89	0.19
141.24	1.24	5.57	0.08	90.68	115.37	115.47	0.19
141.48	1.48	5.55	0.09	90.75	119.16	119.26	0.19
141.71	1.71	5.55	0.10	90.72	122.95	123.05	0.19
141.95	1.95	5.54	0.11	90.95	126.74	126.84	0.20
142.18	2.18	5.55	0.10	91.00	134.32	134.42	0.19
142.42	2.42	5.54	0.12	90.99	138.11	138.21	0.19
142.78	2.78	5.55	0.10	91.18	141.90	142.00	0.19
143.03	3.03	5.55	0.07	91.27	145.68	145.78	0.21
143.27	3.27	5.55	0.04	91.29	153.26	153.36	0.24
143.52	3.52	5.56	0.04	91.11	157.05	157.15	0.25
143.77	3.77	5.56	0.03	91.16	160.84	160.94	0.25
144.01	4.01	5.55	0.03	90.87	164.63	164.73	0.26
144.26	4.26	5.56	0.03	90.83	172.21	172.31	0.25
144.51	4.51	5.56	0.05	90.78	176.00	176.10	0.26
144.75	4.75	5.55	0.10	90.81	180.00	180.10	0.25
145.00	5.00	5.56	0.12	91.09	184.00	184.10	0.26

RF power -5 dBm. LO power +10 dBm

LO Frequency (MHz)	DC Offset (mV) at -5 dBm RF	DC Offset (mV) at +10 dBm LO
104	0.04	0.19
113	0.04	0.19
122	0.04	0.19
131	0.04	0.20
140	0.04	0.19
149	0.04	0.22
158	0.04	0.25
167	0.04	0.26
176	0.04	0.26

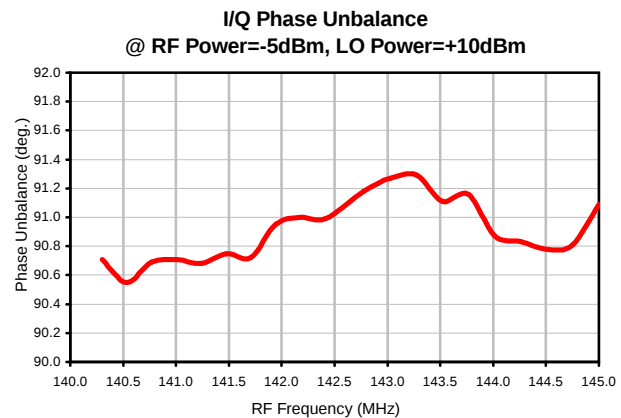
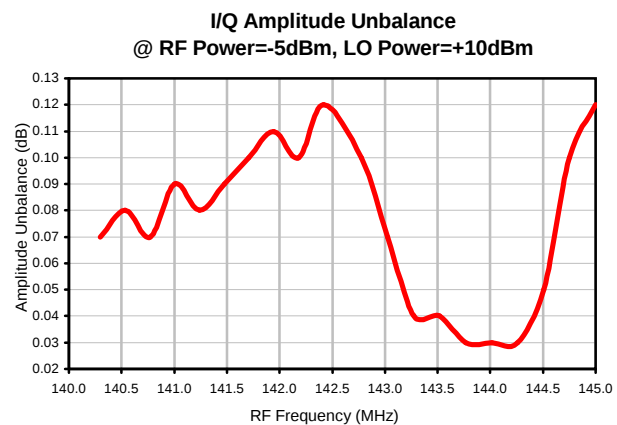
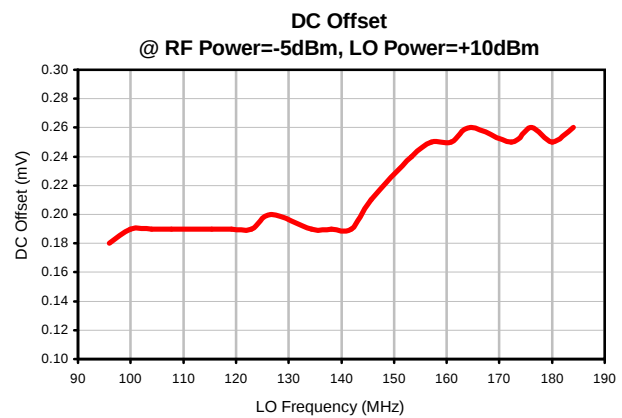
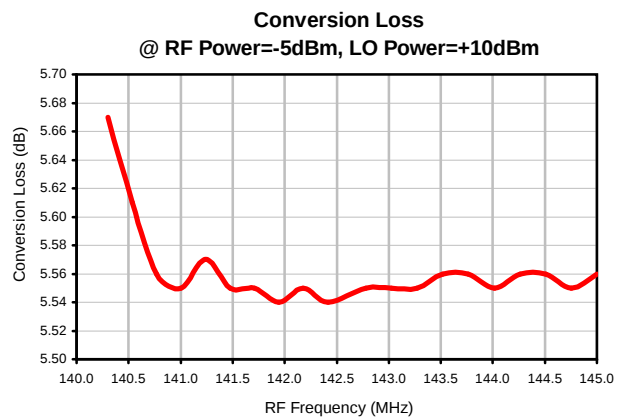
Typical Performance Data

FREQUENCY LO=140MHz (MHz)		CONVERSION LOSS (dB)	AMPLITUDE UNBALANCE (dB)		PHASE UNBALANCE (deg.)	FREQUENCY (MHz)		DC OFFSET (mV)
RF	I/Q		I/Q	I/Q		LO	RF	
140.30	0.30	5.67	0.07	0.07	90.71	96.00	96.10	0.18
140.54	0.54	5.61	0.08	0.08	90.55	100.00	100.10	0.19
140.77	0.77	5.56	0.07	0.07	90.69	104.00	104.10	0.19
141.01	1.01	5.55	0.09	0.09	90.71	107.79	107.89	0.19
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141.95	1.95	5.54	0.11	0.11	90.95	126.74	126.84	0.20
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RF Power=-5 dBm, LO Power=+10 dBm

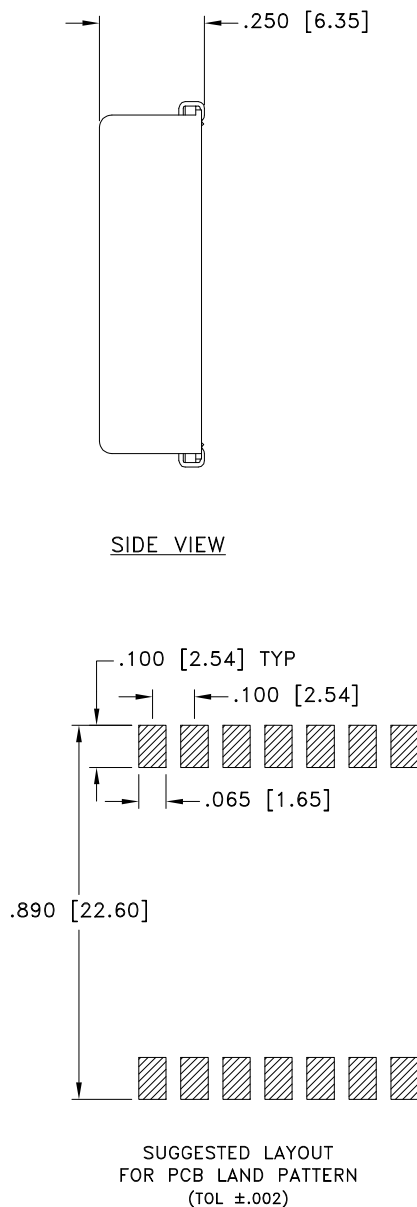
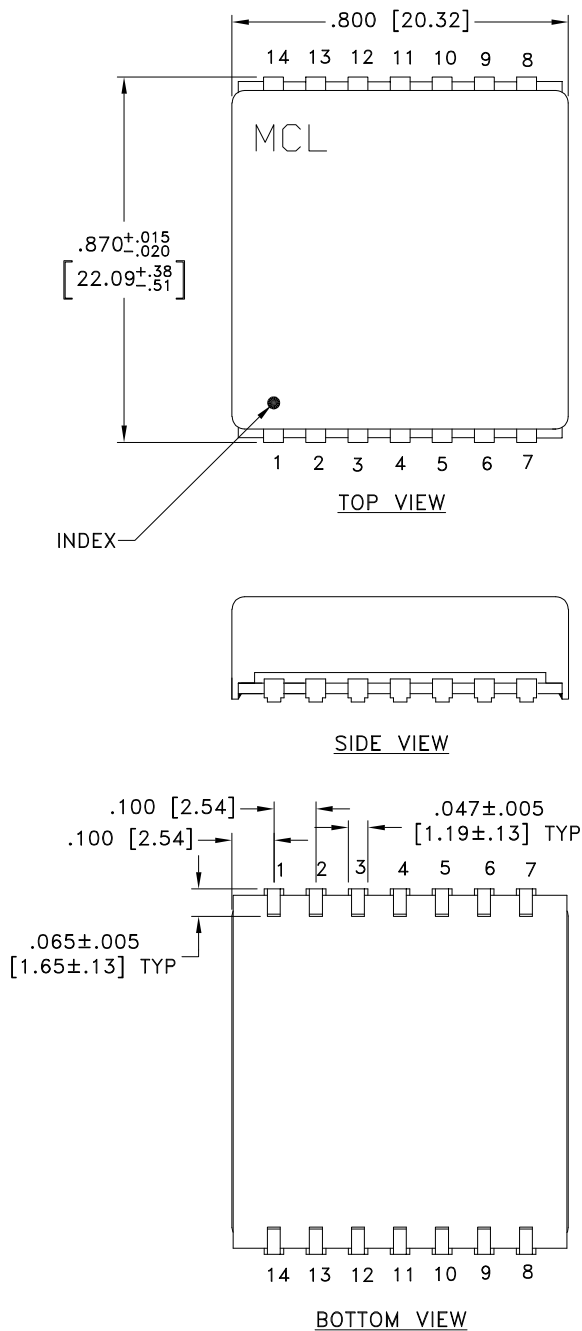
Conversion Loss (dB) = RF Input Power (dBm) - I/Q Output Power (dBm)

Typical Performance Curves



Outline Dimensions

BG291



DENOTES METALLIZATION

Weight: 4 gram

Dimensions are in inches[mm]. Tolerances: 2PL $\pm$ 0.03[0.76]; 3 PL $\pm$ 0.015 [0.381] inches[mm], unless otherwise specified

Notes:

1. Case material: Copper-Nickel alloy.
2. Base material: Printed wiring laminate.
3. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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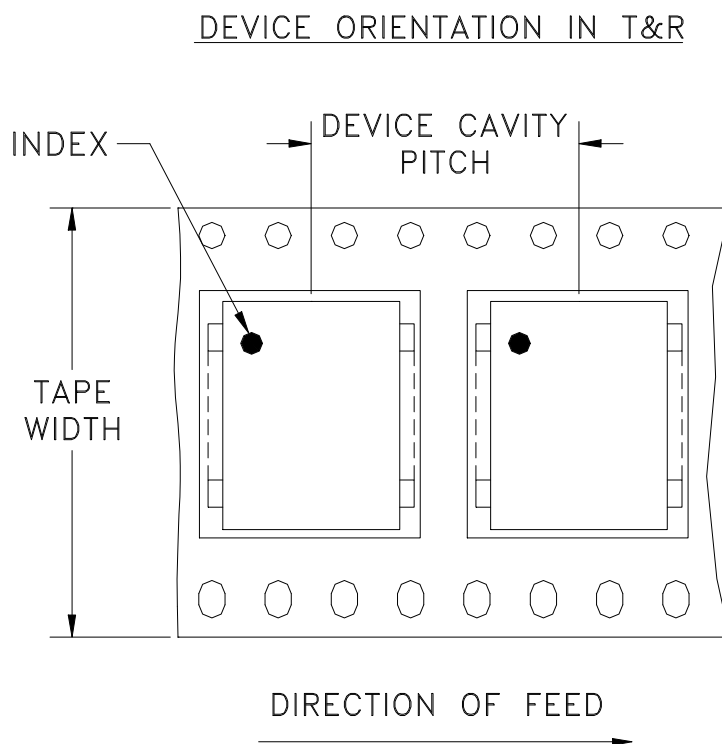
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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F21



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	32	13	200

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



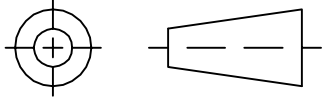
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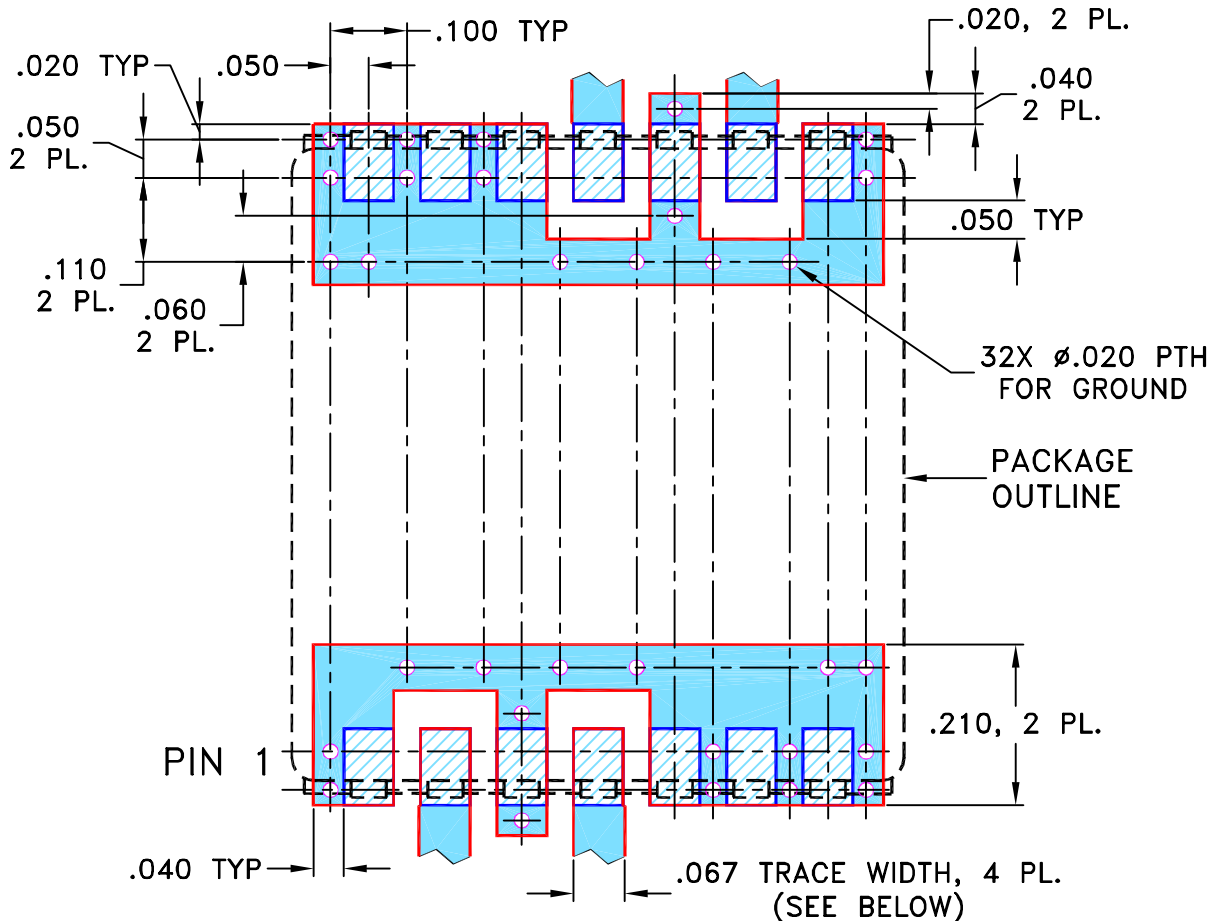
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M100733	NEW RELEASE	09/19/05	MMG	WL
A	M102713	ADDED "...WITH SMOBC"	01/12/06	GT	IL

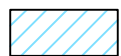
**SUGGESTED MOUNTING CONFIGURATION
FOR BG291 CASE STYLE, "kj" & "hs" PIN CONNECTION**

**NOTE:**

- TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS $.030'' \pm .002''$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

MMG

09/09/05

CHECKED

AV

09/16/05

APPROVED

WL

09/19/05



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Brooklyn NY 11235

PL, kj/hs, BG291, JCIR-4MH/JCIQ, TB-21

SIZE
A

CODE IDENT
15542

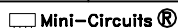
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98-PL-209

REV:
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FILE: 98PL209

SCALE: 4:1

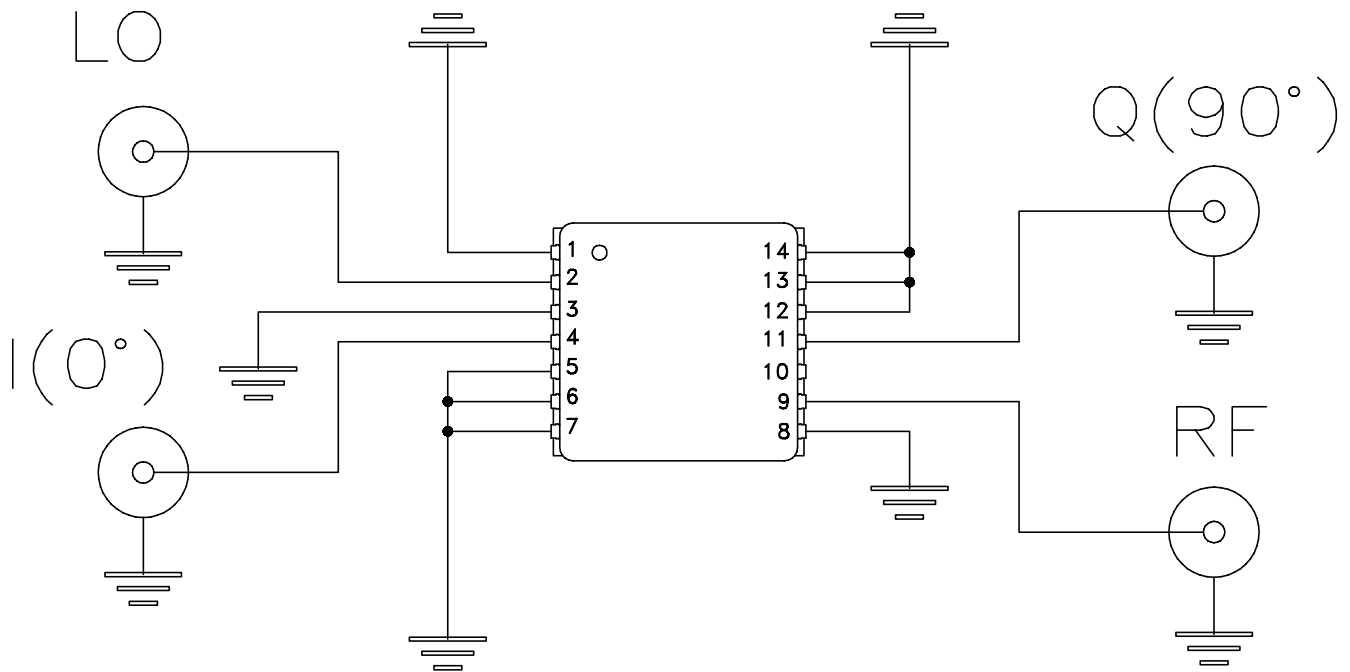
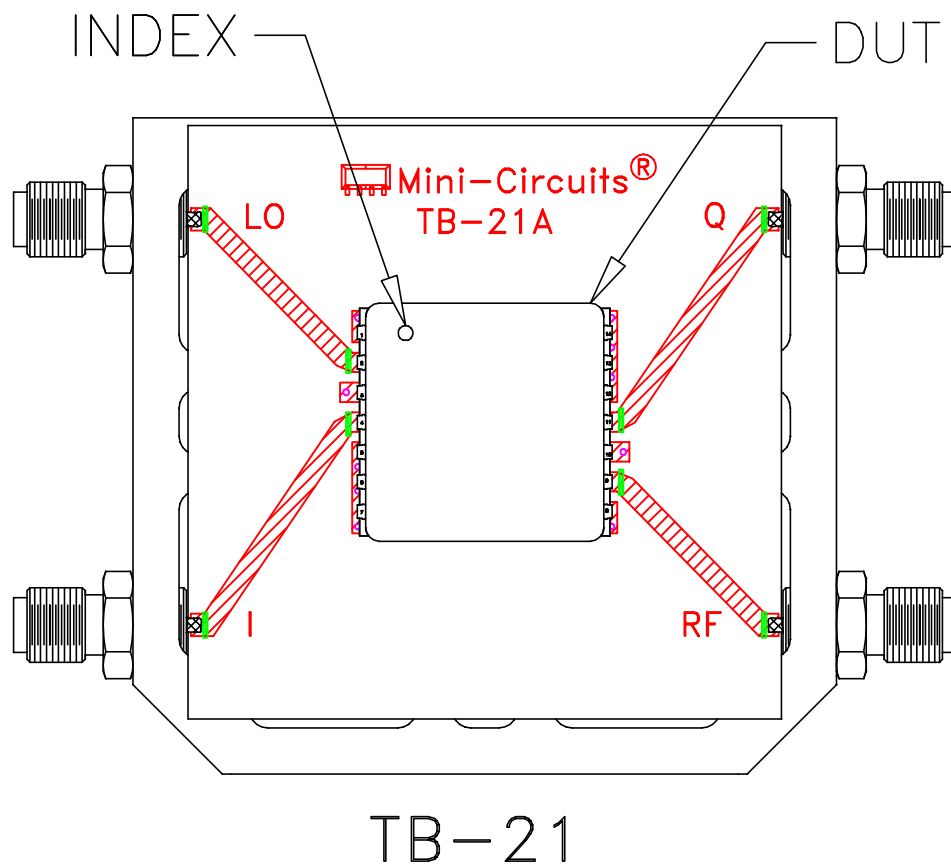
SHEET: 1 OF 1



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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent.
Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215